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Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor:

Dong-Kil Shin, Dong-Ho Lee, Ho-Jeong Moon and Sang-Young Kim

For:

MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF

MANUFACTURING THE SAME

Applicant requests FIG. 4B to be published with the application.

Enclosures:

Specification (pages 1-9); claims (pages 10-12); abstract (page 13)

NINE sheet(s) of FORMAL drawings (comprising 19 figures)

Certified copy of Priority Document No. 2003-0011209, filed February 22, 2003,

from which priority is claimed.

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CLAIMS AS FILED					
For	Number Filed	Number Extra	Rate	Basic Fee \$770	
Total Claims	20-20	0	x \$ 18 =	\$0.00	
Independent Claims	3-3	0	x \$ 86 =	\$0.00	
TOTAL FILING FEE				\$770.00	

\boxtimes	Combined Declaration and Power of	Attorney
\boxtimes	Newly executed (original or copy)	
	Assignment with cover sheet	
	Assignee Name and Address:	Samsung Electronics Co., Ltd.
		Suwon-city, Kyungki-do Republic of Korea
\boxtimes	PTO Form 2038 authorizing credit c	ard payment of \$770.00 (filing fee) is enclosed
\boxtimes	Any deficiency or overpayment shounumber 13-1703.	ald be charged or credited to deposit account

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Respectfully submitted,

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